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HiKey 960 Development Board

SKU 113110004



Description

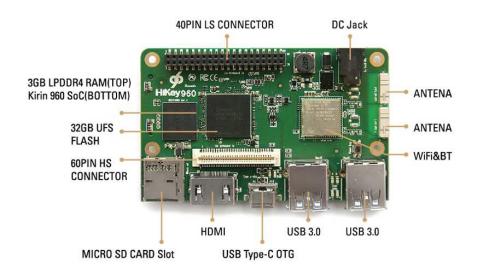
The HiKey 960 is powered by the latest Kirin 960 SoC with four ARM® Cortex®-A73 CPUs (up to 2.3GHz) and four ARM Cortex-A53 CPUs (up to 1.8GHz) configured according to the big.LITTLETM architecture.

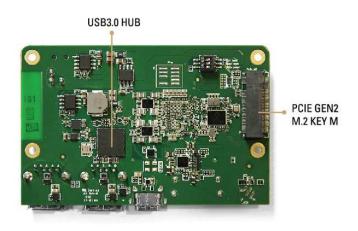


The HiKey 960 is powered by the latest Kirin 960 SoC with four ARM Cortex-A73 CPUs (up to 2.3GHz) and four ARM Cortex-A53 CPUs (up to 1.8GHz) configured according to the big.LITTLE architecture. The integrated MaliTM-G71 MP8 GPU in the Kirin 960 SoC gives the HiKey 960 high performance image processing abilities. With 3GB LPDDR4 memory and 32GB UFS flash on board, the HiKey 960 can be used for most embedded applications.

The HiKey 960 has updated the USB Type-A host from USB2.0 to USB3.0 compared to the original HiKey board. In order to enhance the expansion ability, the HiKey 960 includes a PCIE Gen2 on M.2 M Key connector to enable PCIE device connection. The HiKey 960 also includes an updated WiFi module supporting 2.4GHZ single band to 2.4- and 5.0GHz dual band with two antennas.

Android support for the HiKey 960 will be enabled through Android Open Source Project (AOSP). Additional software suppor will be added through collaboration between Huawei, Linaro and the community.







SoC	Kirin 960 SoC
CPU	4*Cortex A73 (up to 2.3GHz) + 4*Cortex A53 (up to 1.8GHz) Big.LILLTE CPU architecture
GPU	ARM Mali G71 MP8, up to 900MHz
RAM	3GB LPDDR4 SDRAM @ 1866MHz
PMU	Hi6421GWCV530 Hi6422GWCV211 Hi6422GWCV212
Sizes	85mm x 55mm

Features

	32GB UFS flash storage
Storage	MicroSD card slot (SD3.0, SDR104, up to 2TB)
PCIE	PCIE Gen2 on M.2 M Key connector
I CIE	
Wireless	WiFi (2.4- and 5-GHz dual band with two antennas)
VVII CICSS	Bluetooth 4.1
	2 x USB 3.0 type A (host mode only)
USB	1. 1/20 2.0
	1 x USB 2.0 type C OTG
	1 x HDMI 1.4 (Type A - full, up to FHD 1080P)
Display	1 x 4L-MIPI DSI (Supports up to 3840 * 2400 @ 60Hz dual MIPI DSI interface
	LCD screen)
	4K @30fps H.265/H264 video hardware encoder
Video	H265\HEVC MP/High Tier, Main/High Tier, H.264 BP/MP/HP, MPEG 1/2/4,
Video-	11203 till v C Ivii /i ligli Tici, Iviani/i ligli Tici, 11.204 bi /ivii /i li , Ivii EO 1/2/4,
	VC-1, VP6/8, RV8/9/10, DIVX, H265 up to 4K @60fps video hardware decoder

Audio	HDMI output
	1 x Tensilica HiFi3.0 DSP audio subsystem
	1 x WiFi activity LED (Yellow)
Camera	1 x BT activity LED (Blue)
	4 x User LEDs (Green)
Button	Power Button: Button Power on/off & Reset the system
Power Source	Recommend a 12V@2A adapter with a DC plug which has a 4.75mm outer diameter and 1.7mm center pin with standard center-positive (EIAJ-3 Compliant)
OS Support	AOSP/LINUX